

Roll No.

Total Pages : 3

008301

January, 2023

B.Tech.(ECE) IIIrd SEMESTER

Electronic Devices (EC-301)

Time : 3 Hours]

[Max. Marks : 75

Instructions :

1. *It is compulsory to answer all the questions (1.5 marks each) of Part-A in short.*
2. *Answer any four questions from Part-B in detail each question maximum mark is 15.*
3. *Different sub-parts of a question are to be attempted adjacent to each other.*

PART-A

1. (a) Define diffusion constant for holes and give its dimensions. (1.5)
- (b) Write the equation for the net current in a semiconductor. What is the physical significance of each term? (1.5)
- (c) Write the equation of diode. (1.5)
- (d) Write the generalized transistor equation for Bipolar Junction transistor. (1.5)
- (e) Compare the IV Characteristics of PN Junction diode for Ge and Si based diode. (1.5)
- (f) Define volt equivalent of temperature. (1.5)
- (g) What is the input resistance of MOSFET? (1.5)

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- (h) How the Channel resistance in MOSFET can be increased. Explain? (1.5)
- (i) Explain upon what four parameters does the contact difference of potential depend? (1.5)
- (j) Write three properties of silicon wafer. (1.5)

PART-B

2. (a) The equation of continuity is a mathematical statement of what physical law? The left hand side of this equation for holes is dp/dt . The right hand side of this contains several terms. State in words (no mathematics) what each of these terms represent physically. (8)
- (b) For open circuited Bipolar Junction Transistor plot the minority concentration and potential distribution profile for *pnp* type of transistor. (7)
3. (a) Explain the breakdown mechanism in junction diodes in detail. (8)
- (b) Compare the Common Base and Common emitter input and output characteristics for the Bipolar Junction Transistor. (7)
4. (a) A Si sample is doped with 10^{17} arsenic atoms/cm³. (8)
 - (i) Find minority concentration at room temperature.
 - (ii) Find the location of the Fermi level with respect to the intrinsic Fermi level. (Given that $n_i = 1.5 \times 10^{10}$ electrons/cm³).

- (b) Write a short note on doping and diffusion process used in Integrated circuit fabrication. (7)
5. Explain construction and working of n-channel enhancement type MOSFET in detail. Plot its small signal equivalent model when operating in saturation region. (15)
 6. Consider a step graded junction p-n junction with doping profile $N_A > N_D$. Then drive a mathematical relationship for charge density, field intensity and potential as a function of distance from the junction for reverse bias. (15)
 7. (a) Explain the term Etching and its type for device fabrication.
 - (b) Define overdrive voltage and its significance in MOSFET operation.
 - (c) Find the location of Fermi energy level for intrinsic and extrinsic type of semiconductors. (5+5+5)